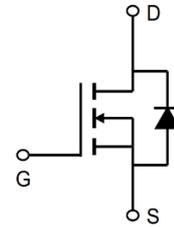


200V N-Channel Enhancement Mode MOSFET

Description

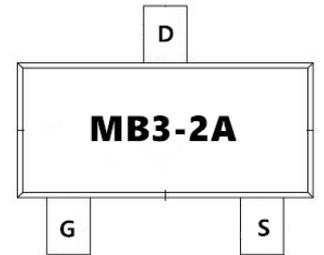
The AP2N20MI is silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system



General Features

$V_{DS} = 200V, I_D = 2A$

$R_{DS(ON)} < 1800m\Omega @ V_{GS} = 10V$



Application

LED dimming
 Emergency lamp



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP2N20MI	SOT23-3L	MB3-2A	3000

Absolute Maximum Ratings (TC=25°C unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage	200	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current-Continuous	2	A
I _{DM}	Drain Current-Pulsed (Note 1)	10	A
P _D	Maximum Power Dissipation	3	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C
R _{θJA}	Thermal Resistance, Junction-to-Ambient (Note 2)	41.7	°C/W

200V N-Channel Enhancement Mode MOSFET

Electrical Characteristics ($T_J=25\text{ }^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	200	-	-	V
$IDSS$	Zero Gate Voltage Drain Current	$V_{DS}=200V, V_{GS}=0V$	-	-	1	μA
$IGSS$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	-	3.0	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=2A$	-	1400	1800	m Ω
g_{FS}	Forward Transconductance	$V_{DS}=15V, I_D=2A$	-	8	-	S
C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V,$ $F=1.0MHz$	-	580	-	PF
C_{oss}	Output Capacitance		-	90	-	PF
C_{rss}	Reverse Transfer Capacitance		-	3	-	PF
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=100V, R_L=15\Omega$ $V_{GS}=10V, R_G=2.5\Omega$	-	10	-	nS
t_r	Turn-on Rise Time		-	12	-	nS
$t_{d(off)}$	Turn-Off Delay Time		-	15	-	nS
t_f	Turn-Off Fall Time		-	15	-	nS
Q_g	Total Gate Charge	$V_{DS}=100V, I_D=2A,$ $V_{GS}=10V$	-	12	-	nC
Q_{gs}	Gate-Source Charge		-	2.5	-	nC
Q_{gd}	Gate-Drain Charge		-	3.8	-	nC
V_{SD}	Diode Forward Voltage ^(Note 3)	$V_{GS}=0V, I_S=2A$	-	-	1.2	V
I_S	Diode Forward Current ^(Note 2)		-	-	2	A

Notes:

- 1、Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2、Surface Mounted on FR4 Board, $t \leq 10$ sec.
- 3、Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
- 4、Guaranteed by design, not subject to production

200V N-Channel Enhancement Mode MOSFET

Typical Electrical and Thermal Characteristics (Curves)

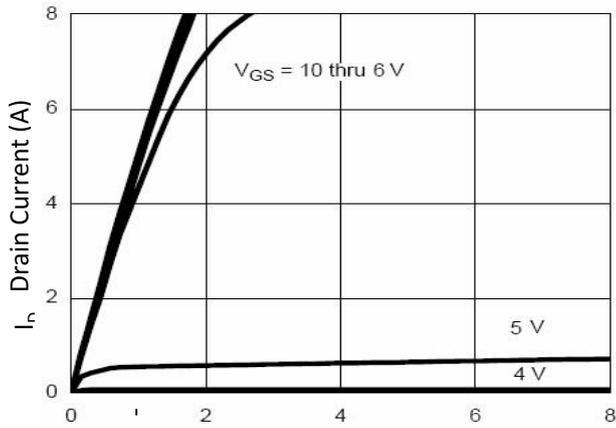


Figure 1 Output Characteristics

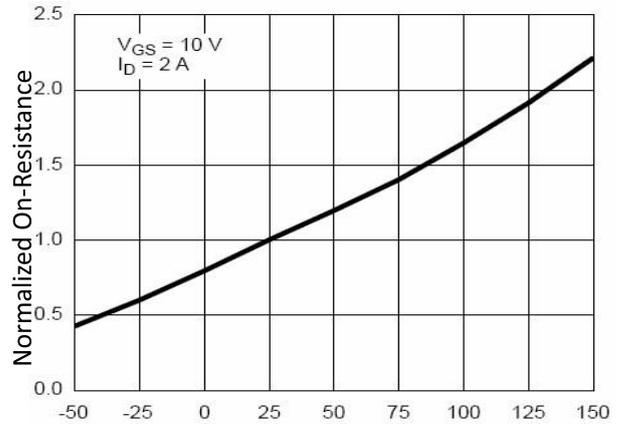


Figure 4 $R_{ds(on)}$ -Junction Temperature

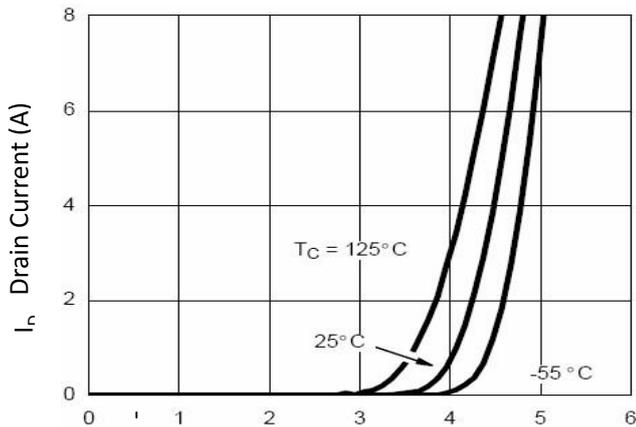


Figure 2 Transfer Characteristics

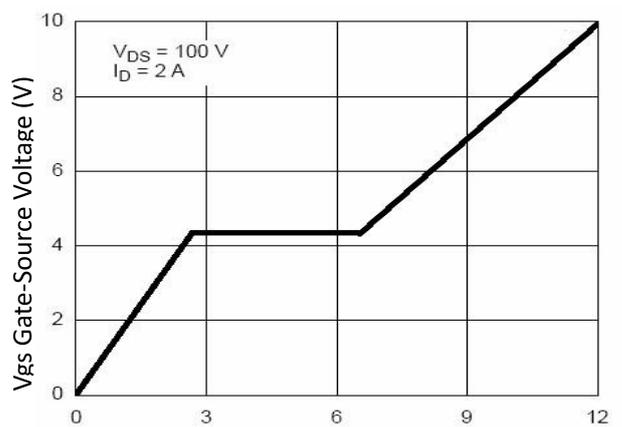


Figure 5 Gate Charge

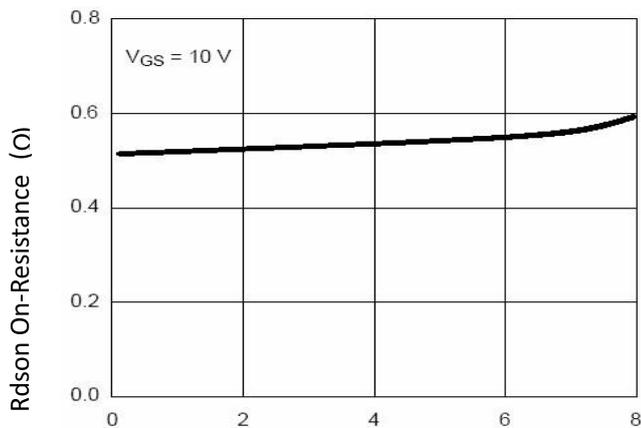


Figure 3 $R_{ds(on)}$ - Drain Current

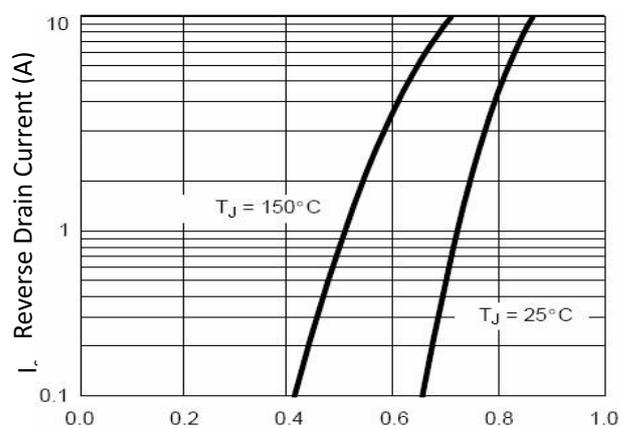


Figure 6 Source- Drain Diode Forward

200V N-Channel Enhancement Mode MOSFET

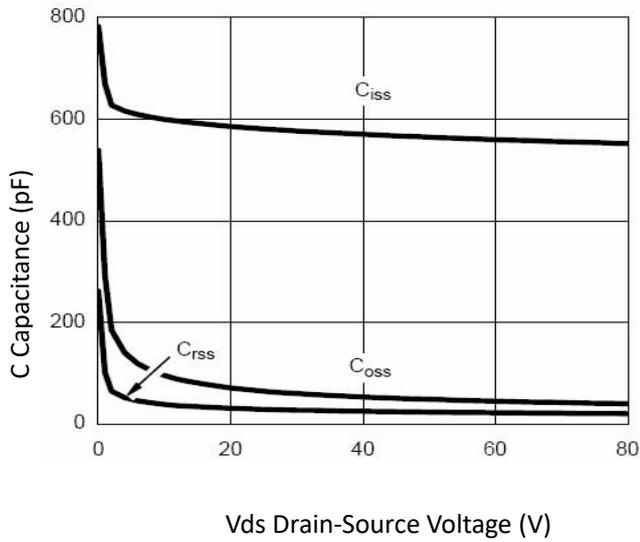


Figure 7 Capacitance vs Vds

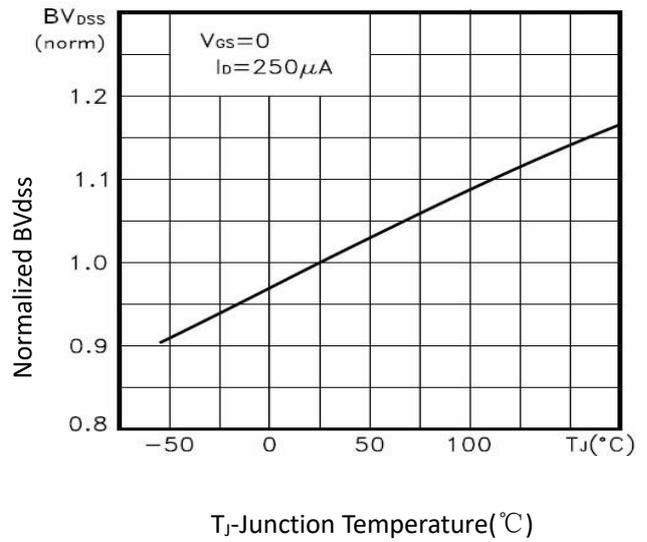


Figure 9 BV_{DSS} vs Junction Temperature

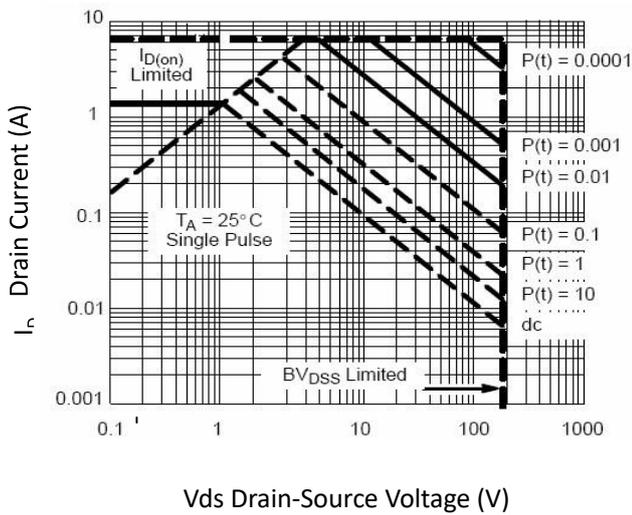


Figure 8 Safe Operation Area

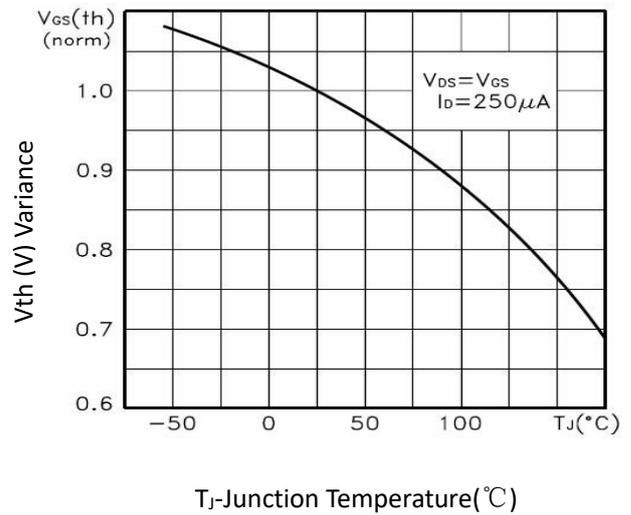


Figure 10 V_{GS(th)} vs Junction Temperature

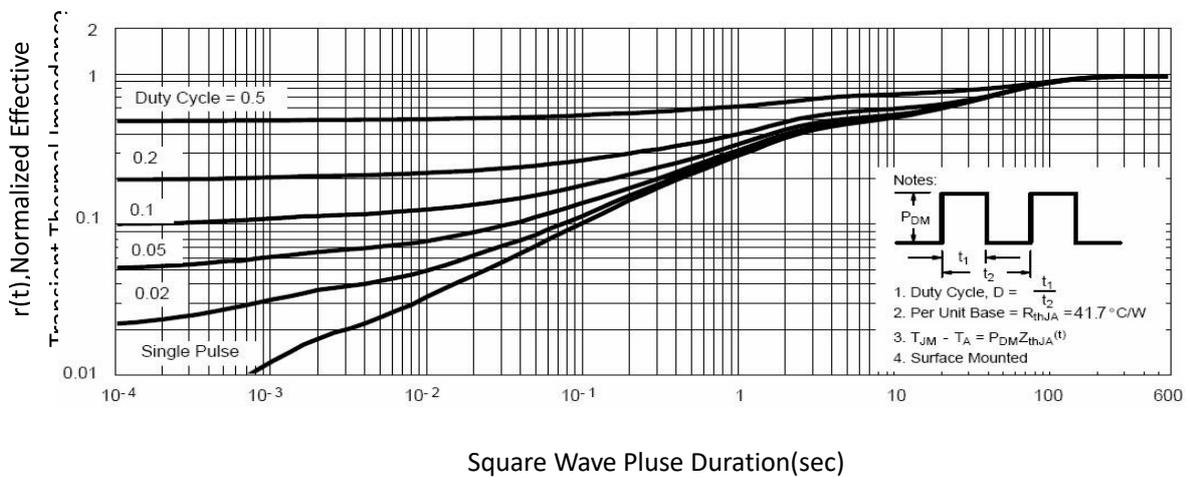
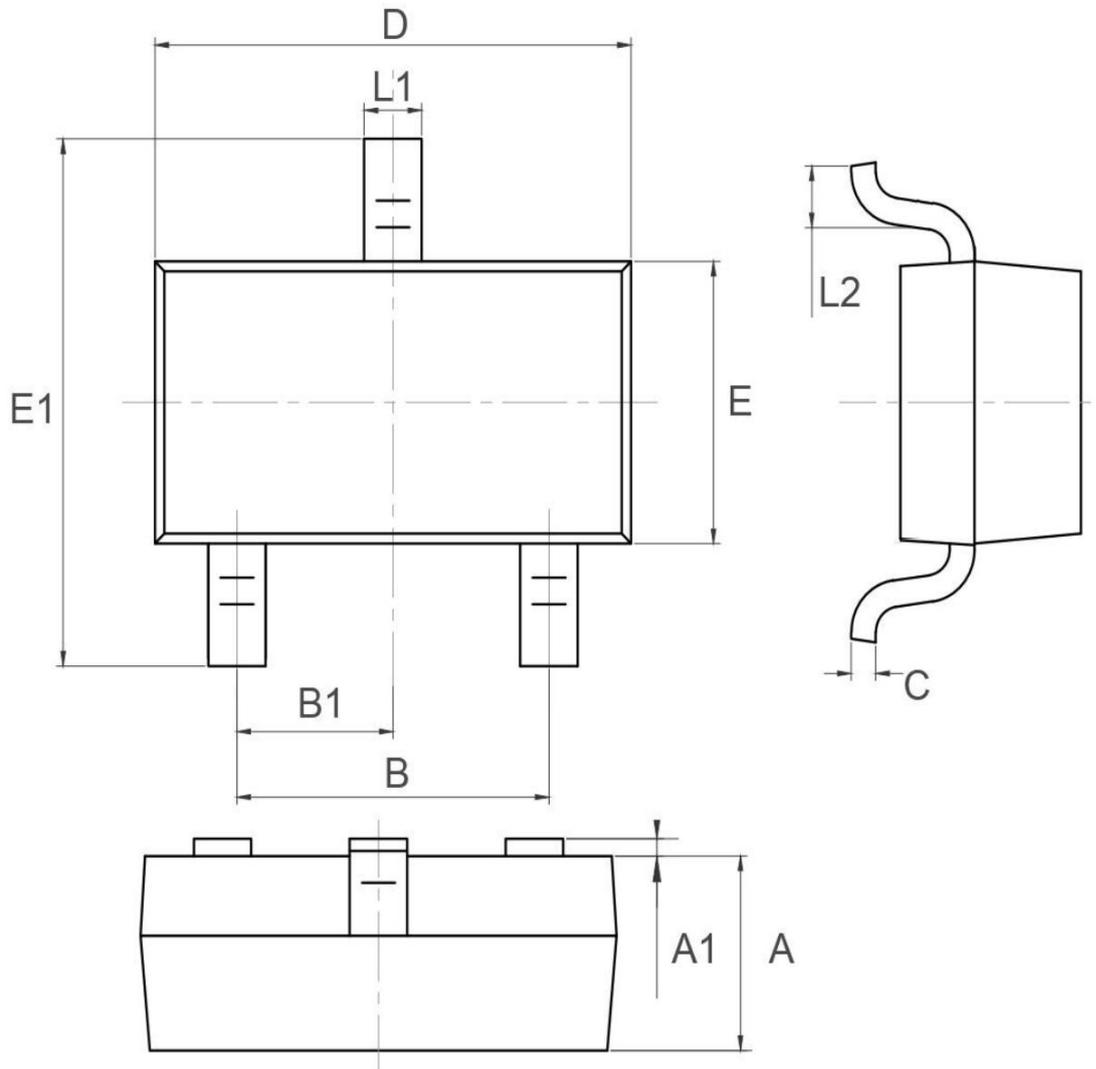


Figure 11 Normalized Maximum Transient Thermal Impedance

Package Mechanical Data: SOT23-3L



Symbol	Dim in mm		
	min.	typ.	max.
A	1	1.1	1.2
A1	0	0.05	0.1
B	1.8	1.9	2
B1	0.95TYP		
C	0.1	0.15	0.2
D	2.82	2.92	3.02
E	1.5	1.6	1.7
E1	2.65	2.8	2.95
L1	0.3	0.4	0.5
L2	0.3	0.45	0.6

200V N-Channel Enhancement Mode MOSFET

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200V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve3.2	2018/1/31	Initial release
Rve3.3	2019/12/01	Reduce RDS
Rve3.4	2020/4/01	Reduce VTH
Rve3.5	2025/6/04	Update LOGO And Corrected Manual POD

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